4 Megabit 3.3V Static RAM
1Mx 4-Bit

Features

- High-speed access times
  Com'l: 8, 10 12, 15, and 20 ns
  Ind'l.: 12, 15, 20 ns
- Low power operation (typical)
  - PDM31098SA
    Active: 300 mW
    Standby: 25 mW
- Single +3.3V (±0.3V) power supply
- TTL-compatible inputs and outputs
- Packages
  Plastic SOJ (400 mil) - SO

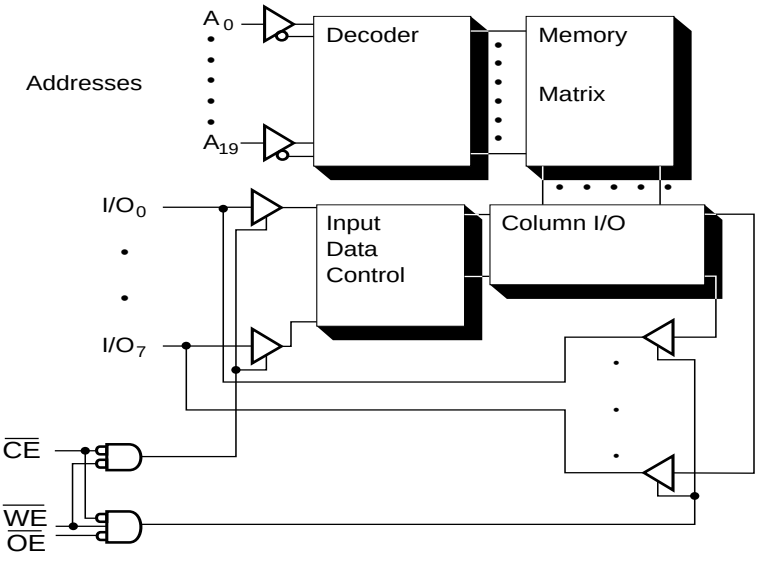
Description

The PDM31098 is a high-performance CMOS static RAMs organized as 1,048,576 x 4 bits. Writing is accomplished when the write enable ($\overline{WE}$) and chip enable $\overline{CE}$ inputs are both LOW. Reading is accomplished when $\overline{WE}$ remains HIGH and $\overline{OE}$ and $\overline{CE}$ are both LOW.

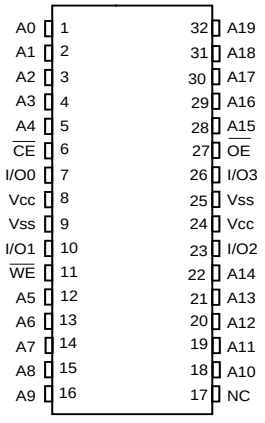
The PDM31098 operates from a single +3.3V power supply and all the inputs and outputs are fully TTL-compatible.

The PDM31098 is available in a 32-pin 400-mil plastic SOJ package.

Functional Block Diagram



SOJ



Pin Configuration

Name	Description
A19-A0	Address Inputs
I/O3-I/O0	Data Inputs/Outputs
$\overline{OE}$	Output Enable Input
$\overline{WE}$	Write Enable Input
$\overline{CE}$	Chip Enable Inputs
NC	No Connect
V_{CC}	Power (+3.3V)
V_{SS}	Ground

Truth Table(1)

$\overline{OE}$	$\overline{WE}$	$\overline{CE}$	I/O	MODE
X	X	H	Hi-Z	Standby
X	X	X	Hi-Z	Standby
L	H	L	D_{OUT}	Read
X	L	L	D_{IN}	Write
H	H	L	Hi-Z	Output Disable

NOTE: 1. H = V_{IH}, L = V_{IL}, X = DON'T CARE

Absolute Maximum Ratings (1)

Symbol	Rating	Com'l.	Ind.	Unit
V_{TERM}	Terminal Voltage with Respect to V_{SS}	–0.5 to +4.6	–0.5 to +4.6	V
T_{BIAS}	Temperature Under Bias	–55 to +125	–65 to +135	°C
T_{STG}	Storage Temperature	–55 to +125	–65 to +150	°C
P_T	Power Dissipation	1.0	1.0	W
I_{OUT}	DC Output Current	50	50	mA
T_j	Maximum Junction Temperature (2)	125	145	°C

NOTE: 1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. Appropriate thermal calculations should be performed in all cases and specifically for those where the chosen package has a large thermal resistance (e.g., TSOP). The calculation should be of the form: $T_j = T_a + P * \theta_{ja}$ where T_a is the ambient temperature, P is average operating power and θ_{ja} the thermal resistance of the package. For this product, use the following θ_{ja} value:

   SOJ: 59° C/W
   TSOP : 90° C/W

DC Electrical Characteristics (V_{CC} = 3.3V, ± 0.3V)

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
I_{LI}	Input Leakage Current	V_{CC} = Max., V_{IN} = V_{SS} to V_{CC}	–5	5	µA
I_{LO}	Output Leakage Current	V_{CC} = Max., $\overline{CE}$ = V_{IH} V_{OUT} = V_{SS} to V_{CC}	–5	5	µA
V_{IL}	Input Low Voltage		–0.3(1)	0.8	V
V_{IH}	Input High Voltage		2.2	Vcc+0.3	V
V_{OL}	Output Low Voltage	I_{OL} = 8 mA, V_{CC} = Min.	—	0.4	V
V_{OH}	Output High Voltage	I_{OH} = –4 mA, V_{CC} = Min.	2.4	—	V

NOTE:1.V_{IL}(min) = –3.0V for pulse width less than 20 ns

Power Supply Characteristics

		-8	-10	-12		-15		-20		
Symbol	Parameter	Com'l	Com'l	Com'l	Ind.	Com'l	Ind.	Com'l	Ind.	Unit
I_{CC}	Operating Current $\overline{CE}$ = V_{IL} f = f_{MAX} = 1/t_{RC} V_{CC} = Max. I_{OUT} = 0 mA	190	175	165	175	155	165	145	155	mA
I_{SB}	Standby Current $\overline{CE}$ = V_{IH} f = f_{MAX} = 1/t_{RC} V_{CC} = Max.	50	45	40	45	35	40	30	35	mA
I_{SB1}	Full Standby Current $\overline{CE}$ ≥ V_{CC} – 0.2V f = 0 V_{CC} = Max., V_{IN} ≥ V_{CC} – 0.2V or ≤ 0.2V	10	10	10	10	10	15	10	15	mA

SHADED AREA = PRELIMINARY DATA
NOTES: All values are maximum guaranteed values.

Capacitance(1) (T_A = +25°C, f = 1.0 MHz)

Symbol	Parameter	Max.	Unit
C_{IN}	Input Capacitance	8	pF
C_{OUT}	Output Capacitance	8	pF

NOTE:1. This parameter is determined by device characterization but is not production tested.

AC Test Conditions

Input pulse levels	V_{SS} to 3.0V
Input rise and fall times	2.5 ns
Input timing reference levels	1.5V
Output reference levels	1.5V
Output load	See Figures 1 and 2

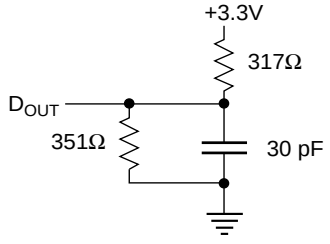


Figure 1. Output Load Equivalent

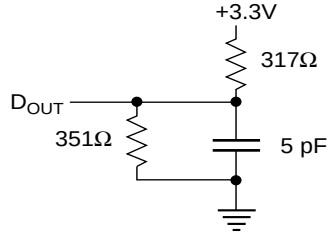
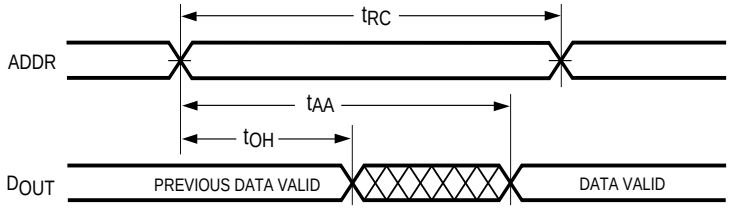
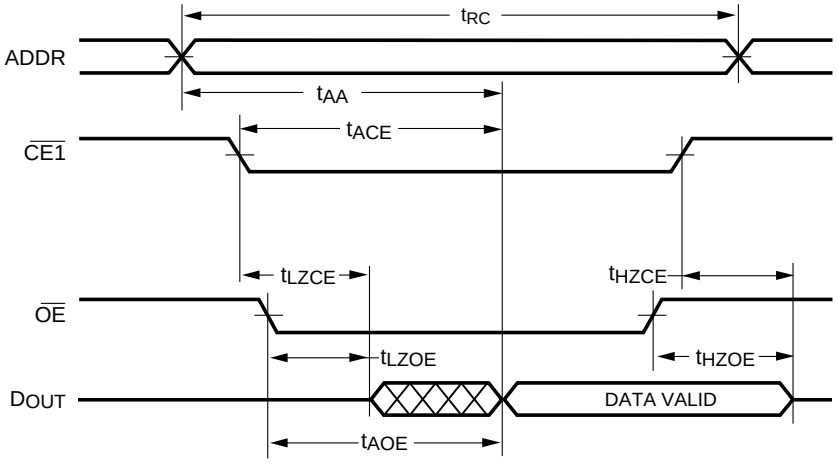


Figure 2. Output Load Equivalent (for TLZCE, tHZCE, tLZWE, tLZOE, tHZOE)

Read Cycle No. 1[4, 5]



Read Cycle No. 2(2, 4, 6)



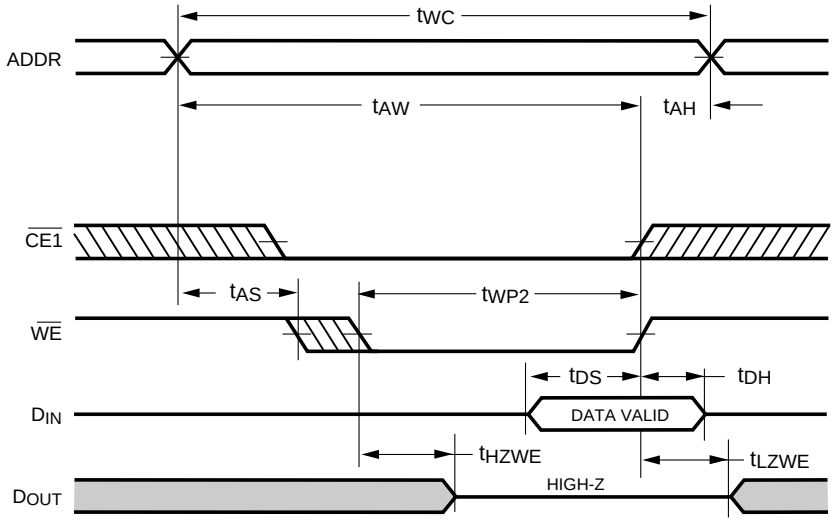
AC Electrical Characteristics

Description		-8*		-10*		–12		–15		–20		
READ Cycle	**Sym**	**Min**	**Max**	**Min**	**Max**	**Min**	**Max**	**Min**	**Max**	**Min**	**Max**	**Units**
READ cycle time	t_{RC}	8	—	10	—	12	—	15	—	20	—	ns
Address access time	t_{AA}	—	8	—	10	—	12	—	15	—	20	ns
Chip enable access time	t_{ACE}	—	8	—	10	—	12	—	15	—	20	ns
Output hold from address change	t_{OH}	3	—	3	—	3	—	3	—	3	—	ns
Chip enable to output in low Z(1,3)	t_{LZCE}	3	—	3	—	3	—	3	—	3	—	ns
Chip disable to output in high Z(1,2,3)	t_{HZCE}	—	4	—	5	—	6	—	7	—	7	ns
Output enable access time	t_{AOE}	—	4	—	5	—	6	—	7	—	8	ns
Output Enable to output in low Z (1,3)	t_{LZOE}	0	—	0	—	0	—	0	—	0	—	ns
Output disable to output in high Z(1,3)	t_{HZOE}	—	4	—	4	—	5	—	6	—	7	ns

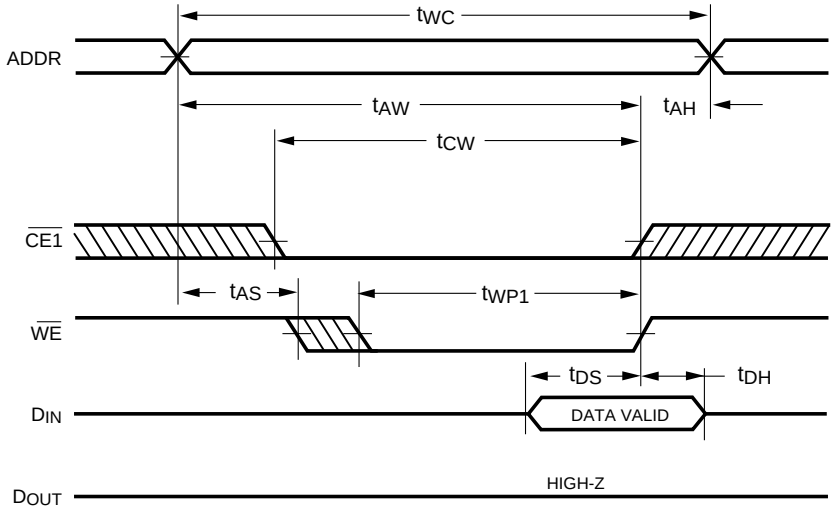
SHADED AREA = PRELIMINARY DATA

* V_{CC} = 3.3V ± 5%

Write Cycle No. 1 (Write Enable Controlled)

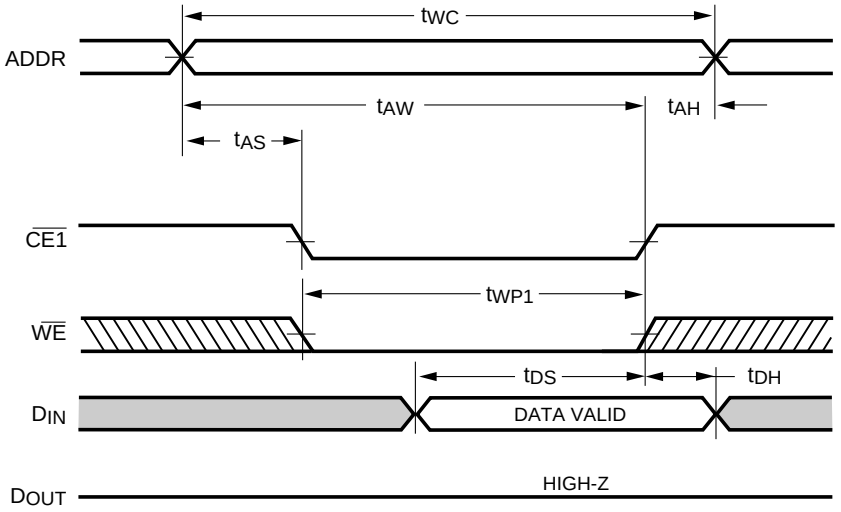


Write Cycle No. 2 (Write Enable Controlled)



NOTE: Output Enable ($\overline{OE}$) is inactive (high)

Write Cycle No. 3 (Chip Enable Controlled)



NOTE: Output Enable ($\overline{OE}$) is inactive (high)

AC Electrical Characteristics

Description		-8*		-10*		-12		-15		-20		
WRITE Cycle	**Sym**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
WRITE cycle time	t_{WC}	8	—	10	—	12	—	15	—	20	—	ns
Chip enable to end of write	t_{CW}	7	—	8	—	10	—	11	—	13	—	ns
Address valid to end of write	t_{AW}	7	—	8	—	10	—	11	—	13	—	ns
Address setup time	t_{AS}	0	—	0	—	0	—	0	—	0	—	ns
Address hold from end of write	t_{AH}	0	—	0	—	0	—	0	—	0	—	ns
Write pulse width	t_{WP}	7	—	8	—	8	—	9	—	10	—	ns
Data setup time	t_{DS}	5	—	6	—	7	—	8	—	9	—	ns
Data hold time	t_{DH}	0	—	0	—	0	—	0	—	0	—	ns
Write disable to output in low Z(1,3)	t_{LZWE}	0	—	0	—	0	—	0	—	0	—	ns
Write enable to output in high Z(1,3)	t_{HZWE}	—	4	—	5	—	6	—	7	—	9	ns

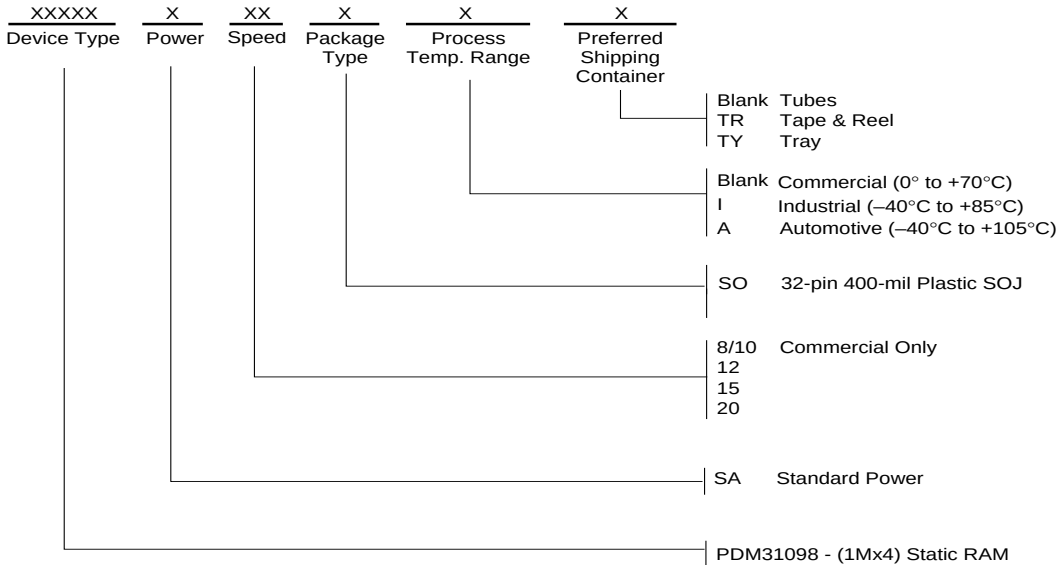
SHADED AREA = PRELIMINARY DATA

* V_{CC} = 3.3V ± 5%

NOTES: (For two previous Electrical Characteristics tables)

1. The parameter is tested with CL = 5 pF as shown in Figure 2. Transition is measured ±200 mV from steady state voltage.
2. At any given temperature and voltage condition, t_{HZCE} is less than t_{LZCE}.
3. This parameter is sampled.
4. $\overline{WE}$ is high for a READ cycle.
5. The device is continuously selected. All the Chip Enables are held in their active state.
6. The address is valid prior to or coincident with the latest occuring Chip Enable.

Ordering Information



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